MX1-10FEP-D

Embedded System for GPU Computing Supports Intel® Coffee Lake Xeon / Core-i Powerful Processor

Introduction

MiTAC's MX1-10FEP-D embedded system is the next generation embedded system with Intel® Coffee Lake C246 workstation chipset which can support Xeon and Core-i LGA1151 socket type processor. The excellent performance, powerful processor, OCP/OVP power protection, and expandable design provide the solution for every complicated task and most types of application.

The MX1-10FEP-D's 8.5 liter chassis design and Xpandable module design give it the possibility to implement the complicated tasks and for every workspace and environment. Flexibilities also mean a rich array of I/O ports (including 2 x Ethernet RJ45, 8 x USB, 1 x HDMl, 1 x DVI-I, 1 x DisplayPort, 2 x COM, PCle X16 + X1 slots, 3-pin Terminal Block Power Input, and 3 x Expansion doors) to add a variety of peripherals. Storage expandability is supported for 3 x high-density hard drives in 2.5" HDD bracket design. The reserved space for dual PCle slots can be used for 1 x GFX Card installation. Two mPCle (shared with mSATA) slots provide the support of SSD and wireless interfaces which allow effortless connection to Wi-Fi and Bluetooth networks, and 4Gconnectivity. DIO/COM/LAN/PoE/Power Ignitoin expansion modules extend the capability and possibility to be used in more applications.





Power Ignition

Dimension (mm)















High shock & vibration



Optional Peripheral

Xpansion Module with 4 x RS232 / 422 / 485, 8-bit Isolated DIDO (4 x DI, 4 x DO)



Xpansion Module

with 4 x Intel i210-IT Giga LAN, RJ45 Port



Xpansion Module

with 4 x Intel i210-IT Giga LAN, M12 Port



Xpansion Module

with 4 x PoE+, Intel i210-IT Giga LAN, RJ45 Port

Xpansion Module

with 4 x PoE+, Intel i210-IT Giga LAN, M12 Port



Xpansion Module

with 2 x PoE +, Intel i210-IT Giga LAN, RJ45 Port





Vehicle Power Ignition Card,

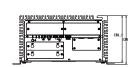
12V/24V and Power ON/OFF Timing Selectable

220W Power Adapter AC to DC, DC24V / 9.2A, 220W*

300W Power Adapter AC to DC, DC24V / 12.5A, 300W*



⁽Over 40°C need derating by 2.5%/°C * AC to DC Accessory for industrial application. Not for railay application



MITAC OMPUTING TECHNOLOGY CORP.

MX1-10FEP-D Embedded System for GPU Computing

CVCTEV			
SYSTEM	Oth 9 9th Con Intal® Coffoo Lako Yoon LC A 1151 Socket Processor 4 care TDP May 90W		
CPU	9th & 8th Gen Intel® Coffee Lake Xeon LGA1151 Socket Processor, 6-core TDP Max. 80W 9th & 8th Gen Intel® Coffee Lake LGA1151 Socket Processor, Core i7/i5/i3 6-core TDP Max. 65W, Core i9 8-core TDP Max 35W		
Chipset	Intel® C246		
System Memory	DDR4 2666MHz, 2 x 260-pin SO-DIMM, Max. 32GB (Xeon: ECC; Core-i: Non-ECC)		
Graphics	Intel® HD Graphics		
Display Interface	HDMI, DisplayPort, DVH		
Storage Slot	3 x 2.5 HDD / SSD (1 w/ Removable HDD Bay, 2 w/ Internal HDD Bracket) 2 x mSATA		
Ethernet	Intel® 1219-LM Giga LAN + 1210-IT Giga LAN		
Audio	Realtek® ALC888		
I/O Chipset	Nuvoton NCT6116D		
TPM Expansion Slot	Nuvoton NPCT750AAAYX Storage: M.2 2242 / 2260 / 2280 M key (PCIe X4 / SATAIII) Storage/LTE/Wireless: 2 x Mini PCIe Full / Half size (USB2.0/ PCIe X1/ SATAIII), w/ SIM Card Holder Wireless: M.2 2230 E key (PCIe X1 / USB2.0) PCIe 3.0 X16, PCIe 3.0 X1 (Option: 2 x PCIe 3.0 X8)		
Indicator	Power LED, HDD LED, DIO LED, LAN1 & 2 ACT / SPEED		
	2 x USB 3.2 Gen1		
	1 x HDMI 1.4		
FRONT I/O	2 x SIM Card Slot w/ Cover		
TROTTI I	1 x 2.5" SATAIII HDD / SSD Bay		
	4 x USB 32 Gen2 (Gbps), 2 x USB 2.0, 2 x RJ-45 , 1 x DisplayPort 1.2, 1 x DVI-I, 1 x PS/2		
	2 x RS232 / 422 / 485 (Support Power 5V / 12V), 1 x Mic-in, 1 x Line-out		
	1 x 2-pin Terminal Block Remote Power on / off		
REAR I/O	1 x 2-pin Terminal Block Remote Power reset		
KLAK I/ O	1 x 4-pin Terminal Block External Fan Connector		
	1 x 3-pin Terminal Block Power Input		
	4 x SMA Antenna (Optional for WiFi/LTE function)		
Edge Al Engine (Optional)	Hailo-8™ M.2 2242 M key (Model Name:M2M-01HAI-MX1)		
	TIGITO 0 M.Z ZZ-Z M RCY (MODEL NATHOLINIZM OTHINI MIXT)		
POWER REQUIREMENT			
Power Input	9~48V Wide Rage DC Input w/ Terminal Block Connectivity		
MECHANICAL			
Thermal Design	 a. Fanless w/o Venting Holes b. With 2 x Internal 40x40x20 System Fan (Supporting NVIDIA GTX1650/GTX1660 Graphic Cards) c. With 2 x Internal 40x40x28 System Fan and Fan Duct (Supporting NVIDIA Tesla T4/P4 GPU Cards) 		
Mounting / Material	Wallmount / Top cover: Aluminum Alloy , Bezel and chassis: Steel		
Dimension	10.6" x 9.7" x 5.0" (268 mm x 246 mm x 128 mm)		
ENVIRONMENTAL			
EITT IN OIT IN EITH	35W TDP Processor: -40°C to 70°C		
Operating Temperature	51~65W TDP Processor: -40°C to 50°C / 71~80W TDP Processor: -40°C to 40°C		
Operating Temperature	*The operating temperature is based on fanless design w/o GPU card installation.		
	**with 0.7m/s Air Flow and Wide Temperature Memory/Storage		
Operating Humidity	10%~90% R/H (Non-condensing)		
,	Operating, 5 Grms, 5-500 Hz, 3 Axes		
Vibration Resistance	(w/ SSD, according to IEC60068-2-64)		
	Operating, 50 Grms, Half-sine 11 ms Duration		
Shock Resistance	(w/ SSD, according to IEC60068-2-27)		
	EMC: CE & FCC		
Certification	Safety: compliant with LVD,EN60950-1 / EN62368-1		
	Compliant with EN50155/EN50121/E-mark		
OS			
OS Support	Windows® 10 64-bit, Linux (support by request)		
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Ordering Information

Model Number	PCIe Slot	Thermal	AC Adaptor
MX1-10FEP-D-C246-FL	X16 + X1	Fanless	None
MX1-10FEP-D-C246-FL-AC300	X16 + X1	Fanless	300W AC to DC Adaptor
MX1-10FEP-D-C246-IF-AC300	X16 + X1	2 x Internal System Fan for PCIe slots	300W AC to DC Adaptor
MX1-10FEP-D-C246-IEF-AC300	X16 + X1	2 x Internal System Fan for PCIe slots 1 x External System Fan	300W AC to DC Adaptor

Packing List

Packing		
• 1 x MX1-10FEP-D	 1 x 3-pin Terminal Block Connector 	 1 x 4-pin Terminal Block Connector
• 1 x CPU Cooler (passive)	1 x DVI to VGA converter	• 1 x Wall Mount Bracket
• 1 x Screw Pack (For HDD)	• 2 x 2-pin Terminal Block Connector	